ABSTRACT

A production method of an electronic device comprising the steps of forming a stacked body by stacking green ~~sheets 10a~~sheets and electrode ~~layers 12a~~layers having a predetermined pattern and firing the stacked body. Before forming the stacked body, a blank pattern ~~layer 24 having substantially the same thickness as that of the electrode~~ layer is formed on a space portion of the electrode layer having a predetermined pattern. The electrode level difference absorbing print paste for forming the blank pattern ~~layer 24~~layer includes at least ceramic powder and a binder resin, and a polymerization degree of the binder resin ~~included in the electrode level difference absorbing print paste~~ is made equal to or more than that of a binder resin included in slurry for forming the green sheet. The binder resin of the electrode level difference absorbing print paste ~~includes a~~ includes polyvinyl butyral ~~resin,~~resin with a polymerization degree of ~~the polyvinyl butyral resin is~~ 1400 or more, a butyralation ~~degree is 64 to 74 mol%,~~ degree of 64 to 74 mol% and an acetalization ~~degree is~~degree of 66 to 74 mol%.